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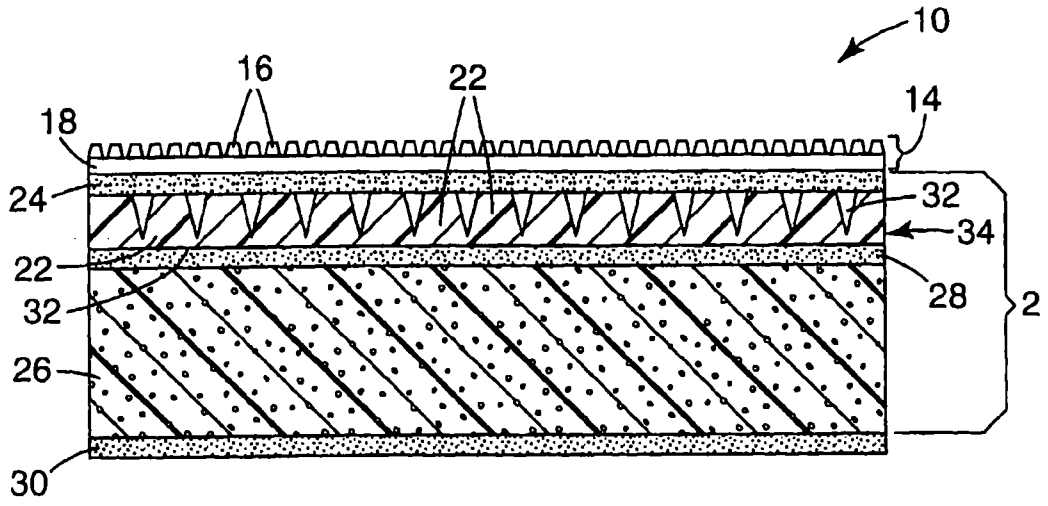
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(54) Title: FIXED ABRASIVE ARTICLE FOR USE IN MODIFYING A SEMICONDUCTOR WAFER



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(57) Abstract: An abrasive article (10) that includes a fixed abrasive element (14) having a plurality of abrasive particles (16), a resilient element, and a plurality of rigid segments (22) disposed between the fixed abrasive element and the resilient element (26).



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